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Product Change Notification - CYER-05QVMR670

Date:	18 Jan 2011
Product Category:	Analog (Linear & Mixed Signal) AND Interface; 16-bit Microcontrollers and Digital Signal Controllers; 8-bit Microcontrollers
Device Family:	
Notification subject:	CCB 998.01: Qualification of CRM-1064L die attach in 28L & 40L PDIP (.600) packages at the MTAI assembly site
Notification text:	PCN Status: Final notification
	Microchip Part#s Affected: See attachments of affected catalog part numbers (CPN) labeled as: PCN_CYER-05QVMR670_Affected_CPN.xls PCN_CYER-05QVMR670_Affected_CPN.pdf
	Description of Change: Qualification of CRM-1064L die attach in 28L & 40L PDIP (.600) packages at the MTAI assembly site
	Impacts to Data Sheet: None
	Reason for Change: To Improve on-time delivery performance
	Change Implementation Status: In Progress
	Estimated First Ship Date: February 28, 2011 (Date code 1110)
	Markings to Distinguish: Traceability code
	PCN_CYER-05QVMR670_Document Revision History: November 8, 2010 – Initial notification issued.Estimated first ship date of January 30, 2011. January 18, 2011 – Final notification issued, which includes an attached qualification report and rev estimated first ship date.

Attachment(s):

PCN_CYER-05QVMR670_Affected_CPN.pdf PCN_CYER-05QVMR670_Affected_CPN.xls PCN_CYER-05QVMR670_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Parts Affected

AY0438
dsPIC30F3011
dsPIC30F3014
dsPIC30F4011
dsPIC30F4013
PIC16C55
PIC16C55A
PIC16C57
PIC16C57C
PIC16C622
PIC16C64A
PIC16C65A
PIC16C65B
PIC16C662
PIC16C67
PIC16C71
PIC16C711
PIC16C715
PIC16C74A
PIC16C74B
PIC16C765
PIC16C77
PIC16C774
PIC16F1934
PIC16F1937
PIC16F1939
PIC16F57
PIC16F59
PIC16F707
PIC16F724
PIC16F727
PIC16F74
PIC16F747
PIC16F77
PIC16F777
PIC16F871
PIC16F874
PIC16F874A
PIC16F877
PIC16F877A
PIC16F884
PIC16F887
PIC16F914

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PIC16F917
PIC17C42A
PIC17C43
PIC17C44
PIC18C442
PIC18C452
PIC18F4220
PIC18F4221
PIC18F4320
PIC18F4321
PIC18F4331
PIC18F43K20
PIC18F43K22
PIC18F4410
PIC18F442
PIC18F4420
PIC18F4423
PIC18F4431
PIC18F4439
PIC18F4450
PIC18F4455
PIC18F4458
PIC18F448
PIC18F4480
PIC18F44J10
PIC18F44K20
PIC18F44K22
PIC18F4510
PIC18F4515
PIC18F452
PIC18F4520
PIC18F4523
PIC18F4525
FIC1014J2J
PIC18F4525
PIC18F4539
PIC18F4539 PIC18F4550
PIC18F4539 PIC18F4550 PIC18F4553
PIC18F4539 PIC18F4550 PIC18F4553 PIC18F458
PIC18F4539 PIC18F4550 PIC18F4553 PIC18F458 PIC18F4580
PIC18F4539 PIC18F4550 PIC18F4553 PIC18F458 PIC18F4580 PIC18F4585
PIC18F4539 PIC18F4550 PIC18F4553 PIC18F458 PIC18F4580 PIC18F4585 PIC18F45510
PIC18F4539 PIC18F4550 PIC18F4553 PIC18F458 PIC18F4580 PIC18F4585 PIC18F4585 PIC18F45J10 PIC18F45K20
PIC18F4539 PIC18F4550 PIC18F4553 PIC18F458 PIC18F4580 PIC18F4585 PIC18F4585 PIC18F45J10 PIC18F45K20 PIC18F45K22

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PIC18F4682
PIC18F4685
PIC18F46J11
PIC18F46J50
PIC18F46K20
PIC18F46K22
TC534
TC7106
TC7106A
TC7107
TC7107A
TC7109
TC7109A
TC7116
TC7116A
TC7117
TC7117A
TC7126
TC7126A
TC7129
TC850